

AMMP-5618

6–20 GHz General Purpose Amplifier



Data Sheet

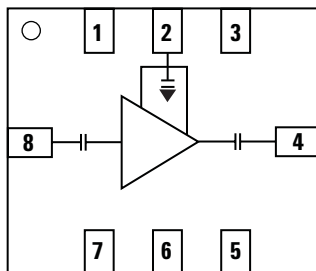


Description

Avago's AMMP-5618 is a high power, medium gain amplifier that operates from 6 GHz to 20 GHz. The amplifier is designed to be an easy-to-use component for any surface mount PCB application. In communication systems, it can be used as a LO buffer, or as a transmit driver amplifier. During typical operation with a single 5V supply, each gain stage is biased for Class-A operation for optimal power output with minimal distortion. The amplifier has integrated 50Ω I/O match, DC blocking, self-bias and choke to eliminate complex tuning and assembly processes typically required by hybrid (discrete-FET) amplifiers. The package is fully SMT compatible with backside grounding and I/O to simplify assembly.

Note: These devices are ESD sensitive. The following precautions are strongly recommended. Ensure that an ESD approved carrier is used when dice are transported from one destination to another. Personal grounding is to be worn at all times when handling these devices.

Functional Block Diagram



Pin	Function
1	NC
2	Vd
3	NC
4	RF_out
5	NC
6	NC
7	NC
8	RF_in

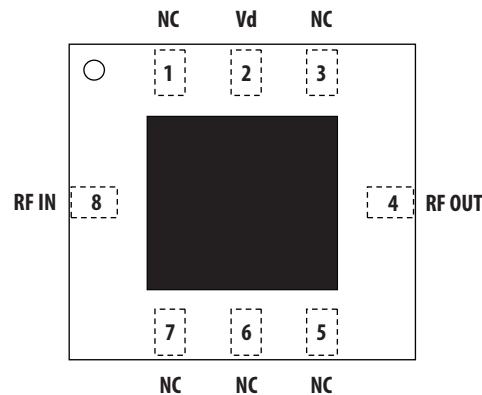
Features

- 5 x 5 mm surface mount package
- Broad band performance 6–20 GHz
- High +19 dBm output power
- Medium 13 dB typical gain
- 50Ω input and output match
- Single 5V (107 mA) supply bias

Applications

- Microwave radio systems
- Satellite VSAT
- Commercial grade military

Package Diagram



RoHS-Exemption



Please refer to hazardous substances table on page 7.



Attention: Observe precautions for handling electrostatic sensitive devices.
ESD Machine Model (Class A) = 50V
ESD Human Body Model (Class 0) = 150V
Refer to Avago Application Note A004R:
Electrostatic Discharge Damage and Control.

Electrical Specifications

1. Small/Large -signal data measured in a fully de-embedded test fixture form $T_A = 25^\circ\text{C}$, $V_d=5\text{V}$, $I_{dq}=107\text{mA}$.
2. Pre-assembly into package performance verified 100% on-wafer per AMMC-5618 published specifications
3. This final package part performance is verified by a functional test correlated to actual performance at one or more frequencies
4. Specifications are derived from measurements in a 50Ω test environment. Aspects of the amplifier performance may be improved over a more narrow bandwidth by application of additional conjugate, linearity, or low noise (Γ_{opt}) matching.

Table 1. RF Electrical Characteristics

Parameter	Typ.	Sigma	Unit	Frequency
Small-signal Gain, G_a	12 13	0.40	dB	5-6 GHz
Noise Figure into 50Ω , NF	4.4	0.2	dB	
Output Power at 1dB Gain Compression, P-1dB	19	0.9	dBm	
Third Order Intercept Point; $\Delta f=100\text{MHz}$; $P_{in}=-20\text{dBm}$, OIP3	25 30	1.2	dBm	5-6 GHz
Input Return Loss, R_{Lin}	-12	0.7	dB	
Output Return Loss, R_{lout}	-12	0.6	dB	
Reverse Isolation, I_{sol}	-40	1.2	dB	

Table 2. Recommended Operating Range

1. Ambient operational temperature $T_A = 25^\circ\text{C}$ unless otherwise noted.
2. Channel-to-backside Thermal Resistance ($T_{channel}$ (T_c) = 34°C) as measured using infrared microscopy. Thermal Resistance at backside temperature (T_b)= 25°C calculated from measured data.

Description	Specifications			Unit	Comments
	Min.	Typical	Max.		
Drain Supply Current, I_d		107	140	mA	($V_d = 5\text{V}$, Under any RF power drive and temperature)

Table 3. Thermal Properties

Parameter	Test Conditions	Value
Thermal Resistance, θ_{ch-b}		$\theta_{ch-b} = 34^\circ\text{C/W}$

Absolute Minimum and Maximum Ratings

Table 4. Minimum and Maximum Ratings

Description	Pin	Specifications		Unit	Comments
		Min.	Max.		
Drain Supply Voltage	V_d		7	V	
Drain Current			150	mA	
RF Input Power (P_{in})	RFIN		20	dBm	CW
Channel Temperature			+150	$^\circ\text{C}$	
Storage Temperature		-65	+150	$^\circ\text{C}$	

Notes:

1. Operation in excess of any one of these conditions may result in permanent damage to this device.

Selected performance plots

These measurements are in 50Ω test environment at TA = 25°C, Vd = 5V, Id = 107 mA. Aspects of the amplifier performance may be improved over a narrower bandwidth by application of additional conjugate, linearity or low noise (Γopt) matching.

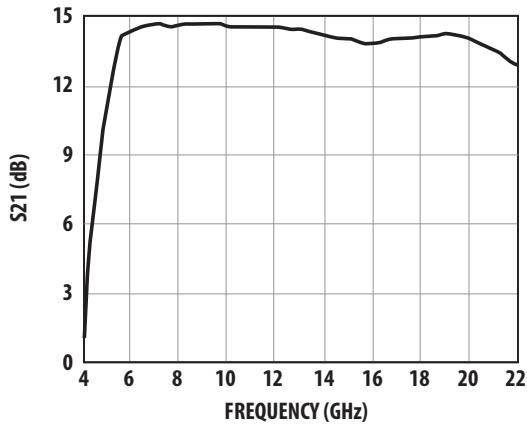


Figure 1. Gain.

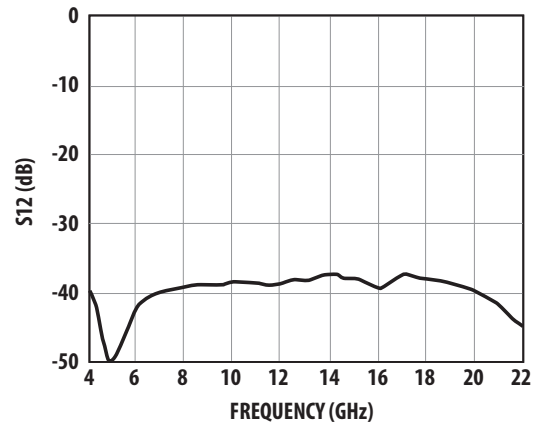


Figure 2. Isolation.

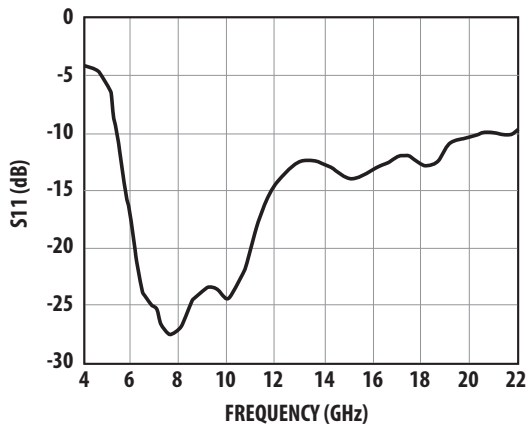


Figure 3. Input Return Loss.

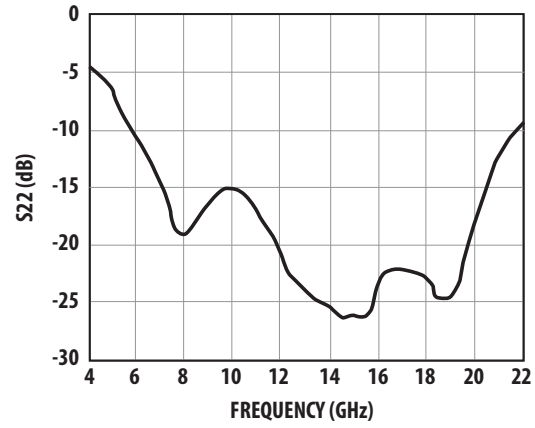


Figure 4. Output Return Loss.

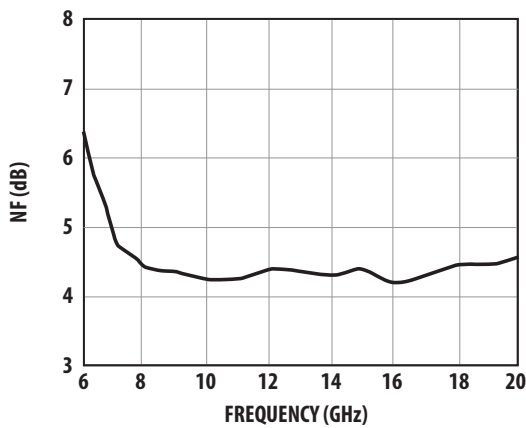


Figure 5. Noise Figure.

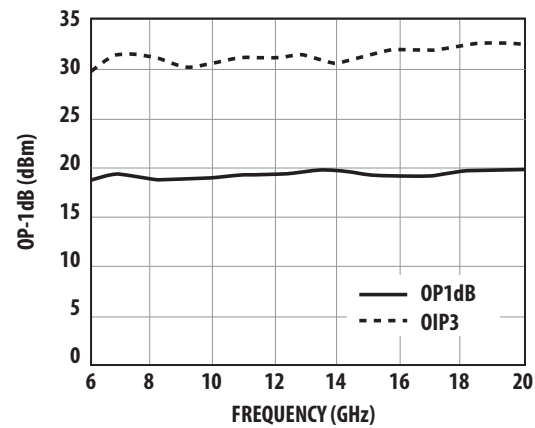


Figure 6. Typical Power, OP-1dB and OIP3.

Over Temperature Performance Plots

These measurements are in 50Ω test environment at TA = 25°C, Vd = 5V, Id = 107 mA. Aspects of the amplifier performance may be improved over a narrower bandwidth by application of additional conjugate, linearity or low noise (Γopt) matching.

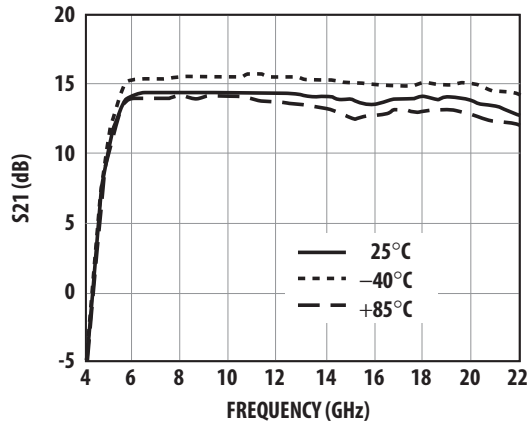


Figure 7. Gain Over Temperature.

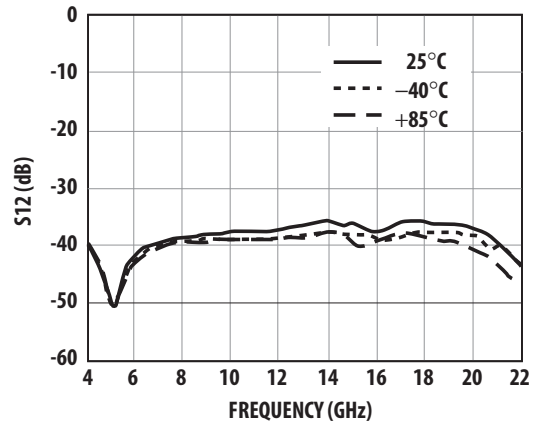


Figure 8. Isolation Over Temperature.

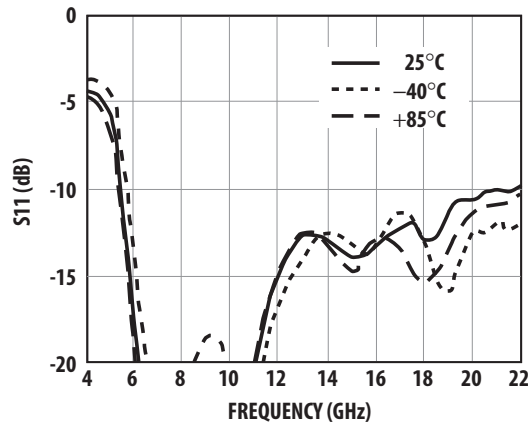


Figure 9. Input RL Over Temperature.

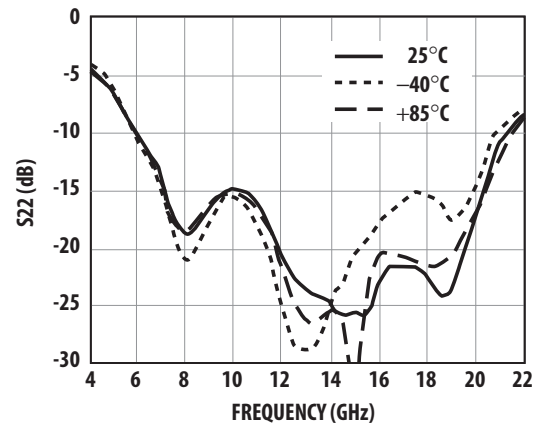


Figure 10. Output Return Loss Over Temperature.

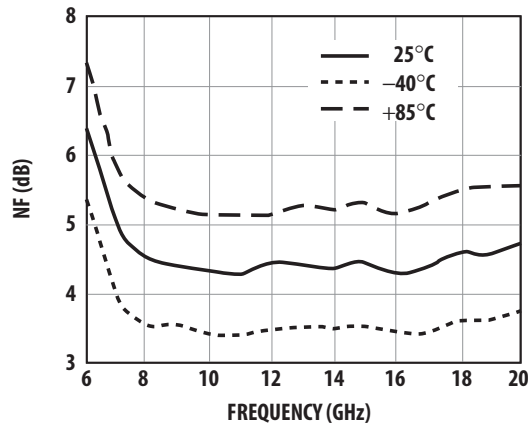


Figure 11. NF Over Temperature.

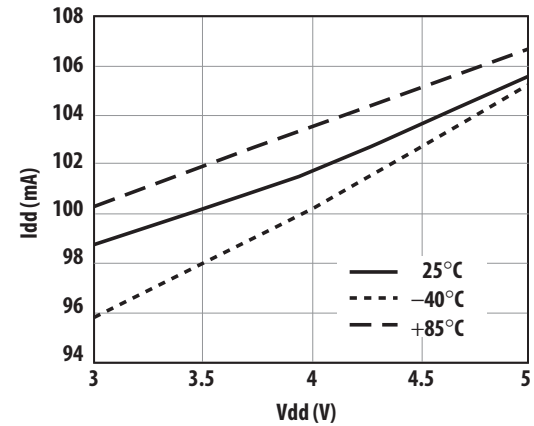


Figure 12. Bias Current Over Temperature.

Over Voltage plots

These measurements are in 50Ω test environment at TA = 25°C, Vd = 5V, Id = 107 mA. Aspects of the amplifier performance may be improved over a narrower bandwidth by application of additional conjugate, linearity or low noise (Γopt) matching.

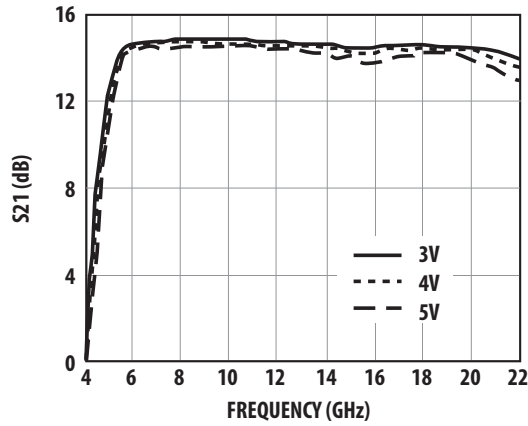


Figure 13. Gain Over Vdd.

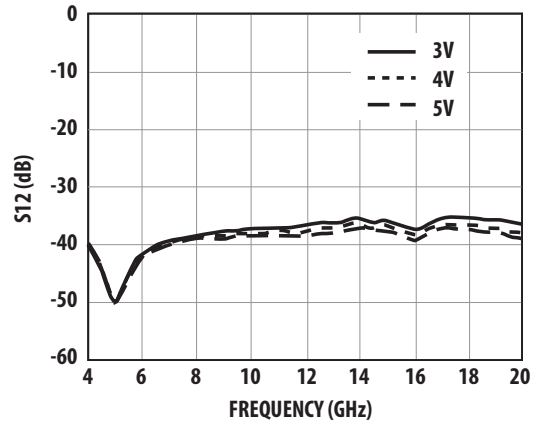


Figure 14. Isolation Over Vdd.

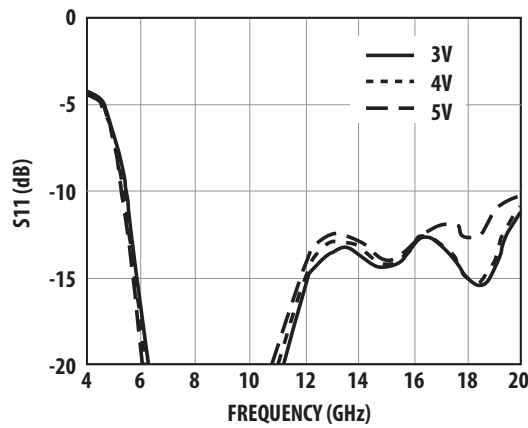


Figure 15. Input RL Over Vdd.

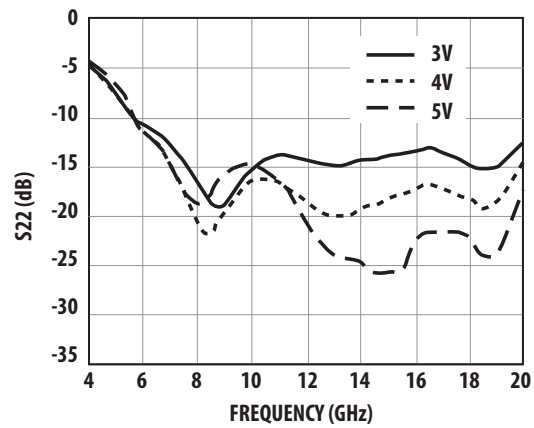


Figure 16. Output Return Loss Over Vdd.

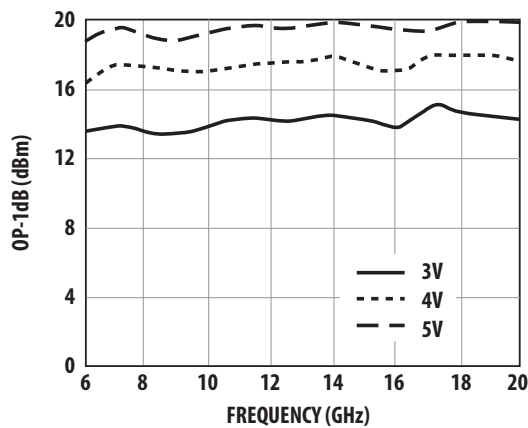


Figure 17. Output Power Over Vdd.

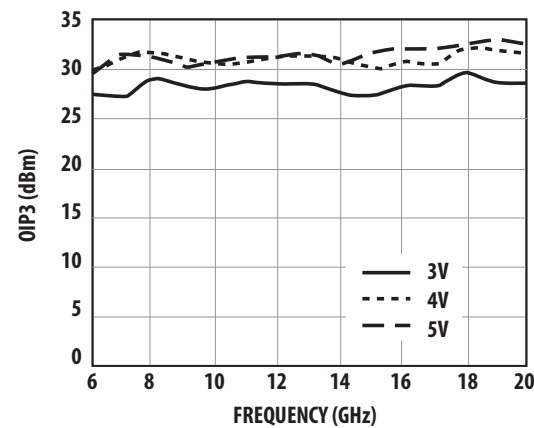


Figure 18. OIP3 Over Vdd.

Typical Scattering Parameters

Please refer to <<http://www.avagotech.com>> for typical scattering parameters data.

Biasing and Operation

The AMMC-5618 is normally biased with a single positive drain supply connected to both V_D pins through bypass capacitors as shown in Figure 19. The recommended supply voltage is 5V. It is important to have 0.1 μ F bypass capacitor, and the capacitor should be placed as close to the component as possible.

The AMMC-5618 does not require a negative gate voltage to bias any of the two stages. No ground wires are needed because all ground connections are made with plated through-holes to the backside of the package.

Refer to the Absolute Maximum Ratings table for allowed DC and thermal conditions.

Application Circuit

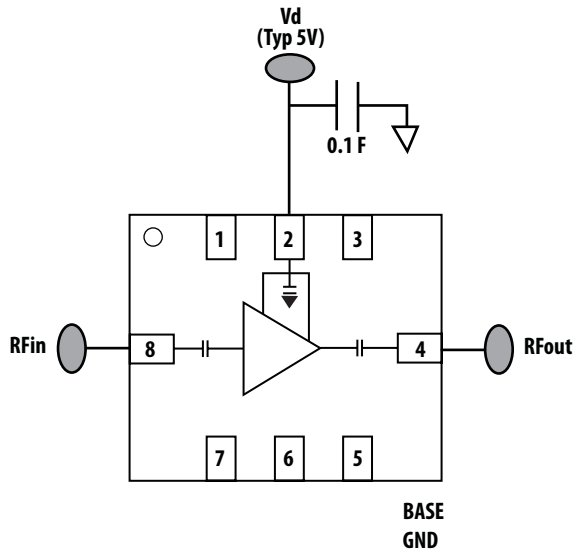


Figure 19. Typical Application.

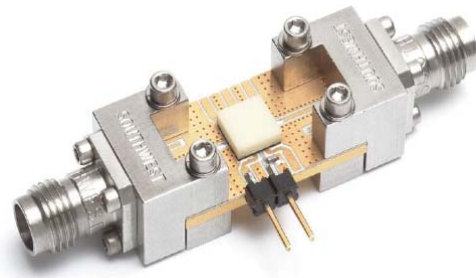


Figure 21. Demonstration Board (available upon request).

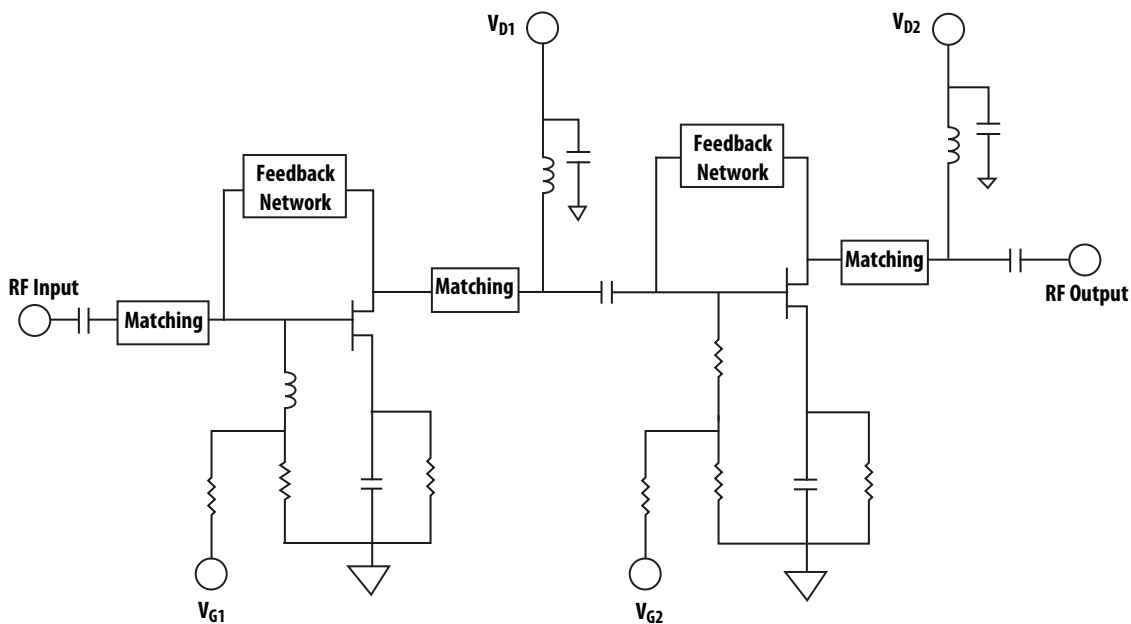


Figure 20. Simplified MMIC Schematic.

Package Dimension, PCB Layout and Tape and Reel information

Please refer to Avago Technologies Application Note 5520, AMxP-xxxx production Assembly Process (Land Pattern A).

Part Number Ordering Information

Part Number	Devices per Container	Container
AMMP-5618-BLK	10	antistatic bag
AMMP-5618-TR1	100	7" Reel
AMMP-5618-TR2	500	7" Reel



Names and Contents of the Toxic and Hazardous Substances or Elements in the Products 产品中有毒有害物质或元素的名称及含量

Part Name 部件名称	Toxic and Hazardous Substances or Elements 有毒有害物质或元素					
	Lead (Pb) 铅 (Pb)	Mercury (Hg) 汞 (Hg)	Cadmium (Cd) 镉 (Cd)	Hexavalent (Cr(VI)) 六价 铬 (Cr(VI))	Polybrominated biphenyl (PBB) 多 溴联苯 (PBB)	Polybrominated diphenylether (PBDE) 多溴二苯醚 (PBDE)
100pF capacitor	x	o	o	o	o	o

o: indicates that the content of the toxic and hazardous substance in all the homogeneous materials of the part is below the concentration limit requirement as described in SJ/T 11363-2006.
x: indicates that the content of the toxic and hazardous substance in at least one homogeneous material of the part exceeds the concentration limit requirement as described in SJ/T 11363-2006.
(The enterprise may further explain the technical reasons for the "x" indicated portion in the table in accordance with the actual situations.)

o: 表示该有毒有害物质在该部件所有均质材料中的含量均在 SJ/T 11363-2006 标准规定的限量要求以下。
x: 表示该有毒有害物质至少在该部件的某一均质材料中的含量超出 SJ/T 11363-2006 标准规定的限量要求。
(企业可在此处, 根据实际情况对上表中打"x"的技术原因进行进一步说明。)

Note: EU RoHS compliant under exemption clause of "lead in electronic ceramic parts (e.g. piezoelectronic devices)"

For product information and a complete list of distributors, please go to our web site: www.avagotech.com

Avago, Avago Technologies, and the A logo are trademarks of Avago Technologies in the United States and other countries.
Data subject to change. Copyright © 2005-2011 Avago Technologies. All rights reserved. Obsoletes 5989-3545EN
AV02-0485EN - May 23, 2011

AVAGO
TECHNOLOGIES